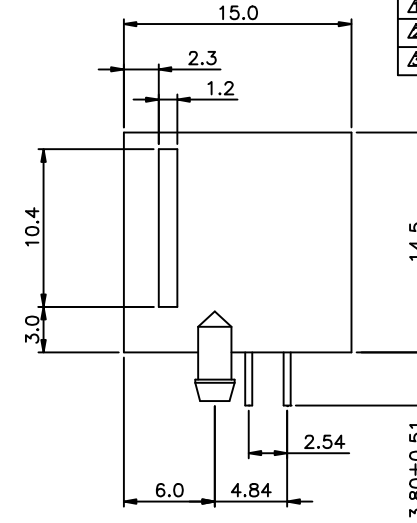
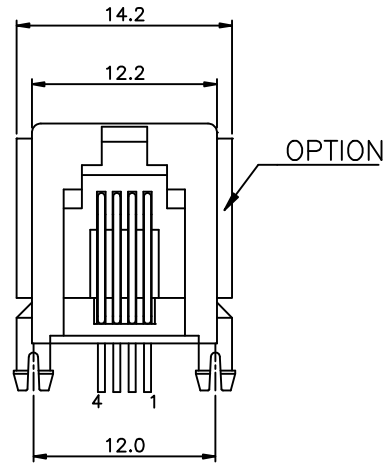


REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD
△		ADD PART NUMBER	05J 7/22/05*	
△		PART NUMBER MODIFY	05J 8/3/05*	
△		ADD P/N.	07 8/06/05*	



**NOTES:**

**ELECTRICAL:**

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

**MECHANICAL:**

1. HOUSING MATERIAL : PBT+30%.G.F.&PBT+15%G.F UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE  $\phi$ 0.46mm.
3. PLATING : GOLD PLATING OVER NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

**ENVIRONMENTAL:**

1. STORAGE : -40°C TO +85°C.
2. OPERATION: 0°C TO 70°C.
3. WAVE SOLDERING TEMPERATURE: 230~250°C (3~5 SECONDS)

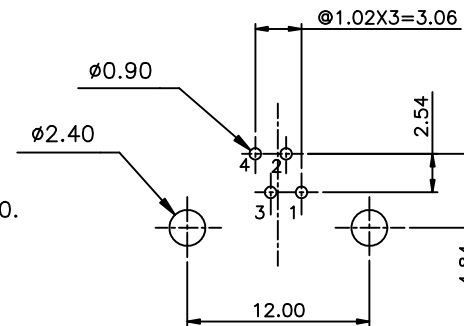
MATES WITH MODULAR PLUG CONFORMING TO

FCC PART 68, SUBPART F.

FREE LEAD PART NUMBER: E554X-HOLXXX-L

- |      |        |           |
|------|--------|-----------|
| 2-2C | 1- 3u" | 2- 6u"    |
| 4-4C | 3-15u" | 4-30u"    |
|      | 5-50u" | 6-Pd 20u" |

- 1Q:A06-2270-L w/ OPTION  
 1R:A06-2380-L w/ OPTION △ △  
 01:A06-1010-L w/ OPTION △



**PC Board Layout**

DETACHED LISTS	MM (INCH)	DFTO YAN	DATE 04/12/05'	FULL RISE ELECTRONIC CO., LTD	
	TOLERANCES EXCEPT AS NOTED	CHKD	DATE		
	MM	MFO	DATE	TITLE SIDE ENTRY L/P PCB JACK	
	.0 ±0.2	APPVL XLF	DATE 08/09/05'		
.00 ±0.15	MATERIAL :		DRAWING NO. GE553A08-LC		
.000 ±0.075	ANGLES ± 0.5	QT'Y :	/PART NO. SEENOTE		
	THIRD ANGLE PROJECTION	FINISH :	DRAWING NO. GE553A08-LC		
		SCALE : 1:1	SHEET X OF Y		